

## 16-3508-301 Information

Heisener.com

For Reference Only

Part Number Manufacturer Category

16-3508-301

**Manufacturer** Aries Electronics

Connectors, Interconnects Sockets for ICs, Transistors

**Description** CONN IC DIP SOCKET 16POS GOLD

Package -

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



Request a Quote

## **Certified Quality**

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









# 16-3508-301 Specifications

Manufacturer Part Number	16-3508-301	
Manufacturer	Aries Electronics	
Category	Connectors, Interconnects	
	Sockets for ICs, Transistors	
Package	-	
Series	508	
Туре	DIP, 0.3" (7.62mm) Row Spacing	
Number of Positions or Pins (Grid)	16 (2 x 8)	
Pitch - Mating	0.100" (2.54mm)	
Contact Finish - Mating	Gold	
Contact Finish Thickness - Mating	30μin (0.76μm)	
Contact Material - Mating	Beryllium Copper	
Mounting Type	Through Hole	
Features	Open Frame	
Termination	Wire Wrap	
Pitch - Post	0.100" (2.54mm)	
Contact Finish - Post	Tin	
Contact Finish Thickness - Post	200μin (5.08μm)	
Contact Material - Post	Brass	
Housing Material	Polyamide (PA46), Nylon 4/6, Glass Filled	
Operating Temperature	-55°C ~ 105°C	
		Report errors?

### 16-3508-301 Guarantees



### **Quality Guarantees**

We provide 90 days warranty. \*

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



#### **Service Guarantees**

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

## **16-3508-301 Payment Methods**



















## 16-3508-301 Shipping Methods













If you have any question about 16-3508-301, please do not hesitate to contact us!

Website: https://www.heisener.com E-mail: salesdept@heisener.com